



## REWORK FLUX RF4

Type ISO 1.2.3.C

Solder Chemistry Rework Flux GEL RF4 has been developed especially for all SMT-repairs or soldering of problematic components like LGN or BGA. Also it could be used for all other known manual soldering applications especially **for military or aerospace electronic**. The RF4 is a flux based on rosins and includes a **L0 class** composition with mild activators. This is the guarantee for the best no-clean property and superior soldering results. Minimal residues, after soldering, showing very high S.I.R. values and temperature stability (dry - not tacky at the use of PCB). The flux residues are easy to remove by using of water based cleaners or organic cleaning agents.

### PHYSICAL PROPERTIES:

Density : ca. 0.98 g/cm<sup>3</sup>  
Solid content: ca. 47%  
PH-value : n.a. (neutral)

**VISCOSITY** (Pa.s) +/-10% measured with Brookfield RVT-DV-II

At 25°C comes to 195.

### STORAGE

At room temperature 12 months

### APPLICATION

The Rework Flux has been designed generally for applications by syringes, but it is suitable for all other kinds of dosages. The used amount of Rework Flux should be completely remelted for the best dry residues.

### PACKING

Syringes: 5ccm,10ccm and 30ccm  
Other kinds of packing can be supplied.

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